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April 1st, 2010
Renesas Electronics Corporation

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H8SX Family

8-Bit Absolute Address Space Switching

Introduction

With an H8SX CPU, any 8-bit absolute address space is selectable as desired.

For all CPUs of the conventional H8S Family, the 8-bit absolute address space is fixed to the range from H’FFFF00 to H’FFFFFF. In the H8SX, the 256-byte area from a desired address specified by the SBR is set as the 8-bit absolute address space.

Target Device

H8SX Family

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1. Overview

With an H8SX CPU, any 8-bit absolute address space is selectable as desired.

For all CPUs of the conventional H8S Family, the 8-bit absolute address space is fixed to the range from H’FFFF00 to H’FFFFFF. In the H8SX, the 256-byte area from a desired address specified by the SBR is set as the 8-bit absolute address space.

2. Applicable Conditions

Table 1  Applicable Condition

<table>
<thead>
<tr>
<th>Item</th>
<th>Contents</th>
</tr>
</thead>
<tbody>
<tr>
<td>Development tool</td>
<td>High-performance Embedded Workshop Ver.4.00.03</td>
</tr>
<tr>
<td>C/C++ compiler</td>
<td>H8S, H8/300 Series, C/C++ Compiler Ver.6.01.01</td>
</tr>
<tr>
<td>H8SX compiler options</td>
<td>-cpu = h8sxa:24:md, -code = machinecode, -optimize = 1, -regparam = 3,</td>
</tr>
<tr>
<td></td>
<td>-speed = (register,shift,struct,expression) -sbr = FF2000</td>
</tr>
</tbody>
</table>

Table 2  Section Settings

<table>
<thead>
<tr>
<th>Address</th>
<th>Section Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>H'001000</td>
<td>P</td>
<td>Program area</td>
</tr>
</tbody>
</table>
3. Configuration

3.1 Short Address Base Register (SBR)

The SBR is a 32-bit register in which the 24 higher-order bits are valid and specify the higher-order address bits for 8-bit absolute addresses. The eight lower-order bits are reserved and read as 0s. The initial value is H’FFFFFF00. The contents of the SBR are changed by using LDC and STC instructions.

<table>
<thead>
<tr>
<th>SBR</th>
<th>31</th>
<th>12</th>
<th>11</th>
<th>0</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>(Reserved)</td>
</tr>
</tbody>
</table>

3.2 Setting the SBR

The address space is set by having assembly instructions directly write to the SBR, or by an assembler or compiler option. The following describes how to set the range from H’FF2000 to H’FF20FF as the 8-bit absolute address space.

1. Writing to the SBR by using assembly instructions
   
   ```
   MOV.L H’FF2000, ER1
   LDC.L ER1, SBR
   ```

2. Setting the SBR by a compiler option (-SBR)
   
   E.g. ch38 sample.c -sbr=FF2000

3.3 Absolute Addresses for the H8SX CPU

The operand value is the contents of a memory location which is pointed to by an absolute address included in the instruction code. The absolute address used to access the data area consists of 8, 16, or 32 bits. Table 3 shows the accessible absolute address ranges.

<table>
<thead>
<tr>
<th>Absolute address in the data area</th>
<th>Ranges for access in advanced mode</th>
</tr>
</thead>
<tbody>
<tr>
<td>8 bits (@aa:8)</td>
<td>Any contiguous 256-byte area (the higher-order address bits are set in SBR)</td>
</tr>
<tr>
<td></td>
<td>The 24 higher-order bits are specified by SBR.</td>
</tr>
<tr>
<td>16 bits (@aa:16)</td>
<td>H’000000 to H’007FFF, H’FF8000 to H’FFFFFFFF</td>
</tr>
<tr>
<td></td>
<td>The 16 higher-order bits are sign-extended.</td>
</tr>
<tr>
<td>32 bits (@aa:32)</td>
<td>H’000000 to H’FFFFFFFF</td>
</tr>
<tr>
<td></td>
<td>A 32-bit absolute address can access any location in the overall address space.</td>
</tr>
</tbody>
</table>
### 3.4 Example of Operation

Figure 1 shows an example of operation when the SBR is set to select the on-chip RAM (from H'FF2000 to H'FF20FF).

1. Conventional, with no SBR setting
   
   MOV.B #imm8, R0L ; 2 bytes/2 cycles  
   MOV.B R0L, @H'FF2000:32; 8 bytes/2 cycles  
   **Total 10 bytes/4 cycles**

2. With an SBR setting (SBR = H'FF2000)
   
   MOV.B #imm8, R0L ; 2 bytes/2 cycles  
   MOV.B R0L, @H'FF2000:8 ; 2 bytes/1 cycle  
   **Total 4 bytes/3 cycles**

---

**Figure 1  Example of SBR Usage**

<table>
<thead>
<tr>
<th>Memory map</th>
<th>User application program</th>
</tr>
</thead>
<tbody>
<tr>
<td>H'000000</td>
<td></td>
</tr>
<tr>
<td>H'0FFFFFFF</td>
<td></td>
</tr>
<tr>
<td>H'FF2000</td>
<td>On-chip RAM</td>
</tr>
<tr>
<td>H'FF20FF</td>
<td></td>
</tr>
</tbody>
</table>
4. Sample Program

4.1 Flowchart

Set SBR to H'FF2000, then confirm access to 8/16/32-bit absolute addresses from the results of compilation.

```
main

TESTREG1 = H'41
Write H'41 to the address H'FF2000. H'41 is written with 8-bit absolute addressing since the address is within the range of 8-bit absolute addresses.

TESTREG2 = H'42
H'42 is written to the address H'FF4000. H'42 is written with 32-bit absolute addressing since the address is in neither the range of 8-bit absolute addresses nor the range of 16-bit absolute addresses.

TESTREG2 = H'43
Write H'43 to the address H'FF8000. H'43 is written with 16-bit absolute addressing since the address is not in the range of 8-bit absolute addresses but is in the range of 16-bit absolute addresses.
```
4.2 Program Listing

A source program written in the C language is given below. This source program was compiled under the conditions described in “2. Applicable Conditions” and the results of compilation are described in section 4.3.

```
/* Application Note */

#include <machine.h>

#define TESTREG1    *(volatile unsigned char  *)0xFF2000
#define TESTREG2    *(volatile unsigned char  *)0xFF4000
#define TESTREG3    *(volatile unsigned char  *)0xFF8000

void main ( void );

#pragma entry main(sp=0xFFC000,vect=0) /* H'0000 : Reset */
#pragma section /* P */

void main ( void )
{
    TESTREG1 = 0x41;    // Access to 8-bit absolute address space
    TESTREG2 = 0x42;    // Access to 32-bit absolute address space
    TESTREG3 = 0x43;    // Access to 16-bit absolute address space

    while(1);
}
```
4.3 Results of Compilation

Assembly code when “-sbr = FF2000” has been specified as a compiler option is shown below. The changes in the number of bytes under CODE with access to 8-, 16-, and 32-bit absolute addresses can be confirmed at values 0010, 0012, and 001A under OFFSET.

<table>
<thead>
<tr>
<th>SCT</th>
<th>OFFSET</th>
<th>CODE</th>
<th>LABEL</th>
<th>INSTRUCTION</th>
<th>OPERAND</th>
<th>COMMENT</th>
</tr>
</thead>
<tbody>
<tr>
<td>P</td>
<td>00000000</td>
<td>_main:</td>
<td></td>
<td></td>
<td></td>
<td>section</td>
</tr>
<tr>
<td></td>
<td>00000000</td>
<td>7A0700FFC000</td>
<td>MOV.L</td>
<td>#H'00FFC000,SP</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>00000006</td>
<td>7A0300FF2000</td>
<td>MOV.L</td>
<td>#H'00FF2000,ER3</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>0000000C</td>
<td>0373</td>
<td>LDC.L</td>
<td>ER3,SBR</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>0000000E</td>
<td>F841</td>
<td>MOV.B</td>
<td>#H'41:8,ROL</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>00000010</td>
<td>3800</td>
<td>MOV.B</td>
<td>ROL,#H'00FF2000:8</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>00000012</td>
<td>017D484200FF4000</td>
<td>MOV.B</td>
<td>#H'42:8,#H'00FF4000:32</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>0000001A</td>
<td>017D40438000</td>
<td>MOV.B</td>
<td>#H'43:8,#H'00FF8000:16</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>00000020</td>
<td>L16:</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>00000020</td>
<td>4000</td>
<td>BRA</td>
<td>L16:8</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
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<table>
<thead>
<tr>
<th>Rev.</th>
<th>Date</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.00</td>
<td>May.18.07</td>
<td>First edition issued</td>
</tr>
</tbody>
</table>
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